



2A TrenchSBR TRENCH SUPER BARRIER RECTIFIER

Product Summary

V _{RRM} (V)	I _O (A)	V _F (MAX) (V) @ +25°C	I _{R(MAX)} (mA) @ +25°C	
10	2	0.4	0.25	

Features and Benefits

- Patented TrenchSBR technology provides superior avalanche capability versus schottky diodes, ensuring more rugged and reliable end applications.
- Reduced ultra-low forward voltage drop (V_F); Better efficiency and cooler operation.
- Reduced high temperature reverse leakage; Increased reliability against thermal runaway failure in high temperature operation.
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Description and Applications

The SBRT2M10LP provides very low V_F and excellent reverse leakage stability at high temperatures. It is ideal for use as bypass and rectifier, freewheel diode or blocking diode in applications such as:

- Solar Panels
- Blocking Diodes
- Bypass Diodes
- Boost Diodes
- Recirculating Diodes

Mechanical Data

- Case: X1-DFN1411-3
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208[®]
- · Polarity: See Below
- Weight: 2.35 mg (Approximate)

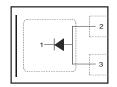
X1-DFN1411-3







Bottom View



Top View Internal Schematic

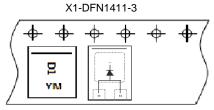
Ordering Information (Note 4)

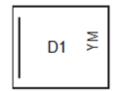
Part Number	Case	Packaging
SBRT2M10LP-7	X1-DFN1411-3	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information





D1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: C = 2015) M = Month (ex: 6 = June) Bar=Cathode

Date Code Key

Date Code Rey												
Year	2014	20)15	2016	2017	20	18	2019	2020	20)21	2022
Code	В		С	D	Е		F	G	Н		I	J
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	10	V
Average Rectified Output Current	Io	2	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	25	Α

Thermal Characteristics

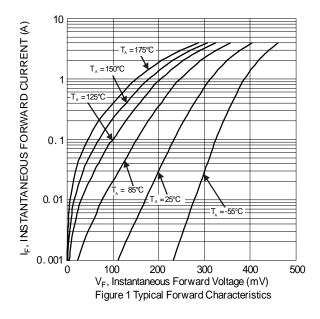
Charact	eristic	Symbol	Value	Unit	
Typical Thermal Resistance Junction to Case (Note 5)			25	°C/W	
Typical Thermal Resistance Junction to Ambient (Note 5)			100	°C/W	
	V _R ≤ 80% V _{RRM}		-55 to +150		
Operating Temperature Range	V _R ≤ 50% V _{RRM}	T_J	≤ +175	°C	
	DC Forward Mode (Note 7)		≤ + 200		
Storage Temperature Range			-55 to +150	°C	

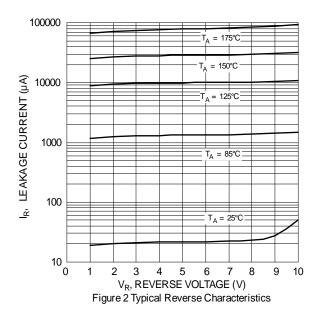
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Forward Voltage Drop (Note 6)	V _F	_	_	0.4	V	I _F = 2A, T _J = +25°C
Leakage Current (Note 6)	I _R		— 10.8	250 —		$V_R = 10V, T_J = +25$ °C $V_R = 10V, T_J = +125$ °C

Notes:

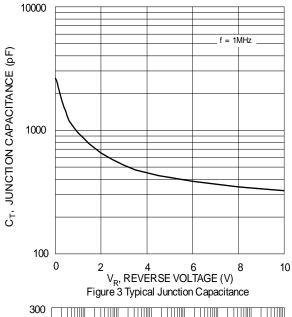
- Device mounted on FR-4 PCB pad layout 1inch 2oz copper.
 Short duration pulse test used to minimize self-heating effect.
 Maximum junction temperature guaranteed for two hours.

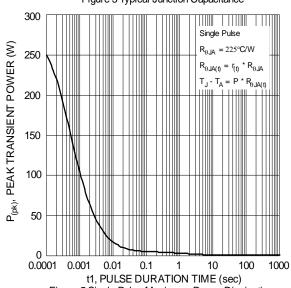


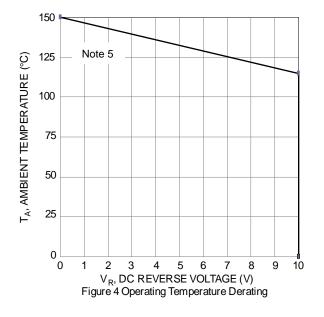


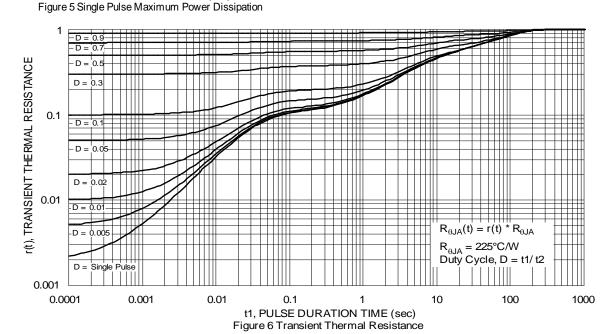








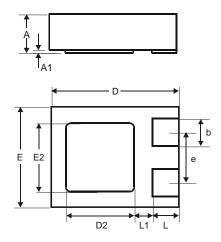






Package Outline Dimensions

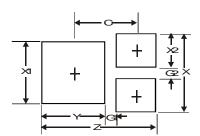
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X1-DFN1411-3							
Dim	Min	Max	Тур				
Α	0.47	0.53	0.50				
A1	0.00	0.05	0.02				
b	0.25	0.35	0.30				
D	1.35	1.475	1.40				
D2	0.65	0.85	0.75				
Е	1.05	1.175	1.10				
E2	0.65	0.85	0.75				
е			0.55				
L	0.225	0.325	0.275				
L1	_	_	0.20				
All Dimensions in mm							

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	value (in mm)
Z	1.38
G1	0.15
G2	0.15
Х	0.95
X1	0.75
X2	0.40
Υ	0.75
С	0.76



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